

Handwritten: C1
Claim 9 (amended). Electrically conductive, thermoplastic and heat-activatable adhesive film, comprising

- i) a thermoplastic polymer in a proportion of from 30 to 89.9% by weight,
 - ii) a) one or more tackifying resins in a proportion of from 5 to 50% by weight or
b) epoxy resins with hardeners, with or without accelerators, in a proportion of from 5 to 40% by weight, or
c) both said one or more tackifying resins in a proportion of from 5 to 50% by weight and said epoxy resins with hardeners, with or without accelerators, in a proportion of from 5 to 40% by weight,
- and
- iii) silver-coated glass beads in a proportion of from 0.1 to 40% by weight,
 - iv) where the diameter of the glass beads is at least equal to the thickness of the adhesive film.

Handwritten: C2
Claim 10 (Twice Amended). Adhesive film according to Claim 9, wherein the thermoplastic polymer comprises a member selected from the group consisting of thermoplastic polyolefins, polyesters, polyurethanes or polyamides and modified rubbers.

*Handwritten: C3
Sub D2*
Claim 15 (Amended). A method for implanting electrical modules in a card body provided with a cutout for accommodating an electronic module which on